Experiment 1

Internal 32kHz Enable 32kHz calibration Active 1ms / PM2 20ms

Experiment 2

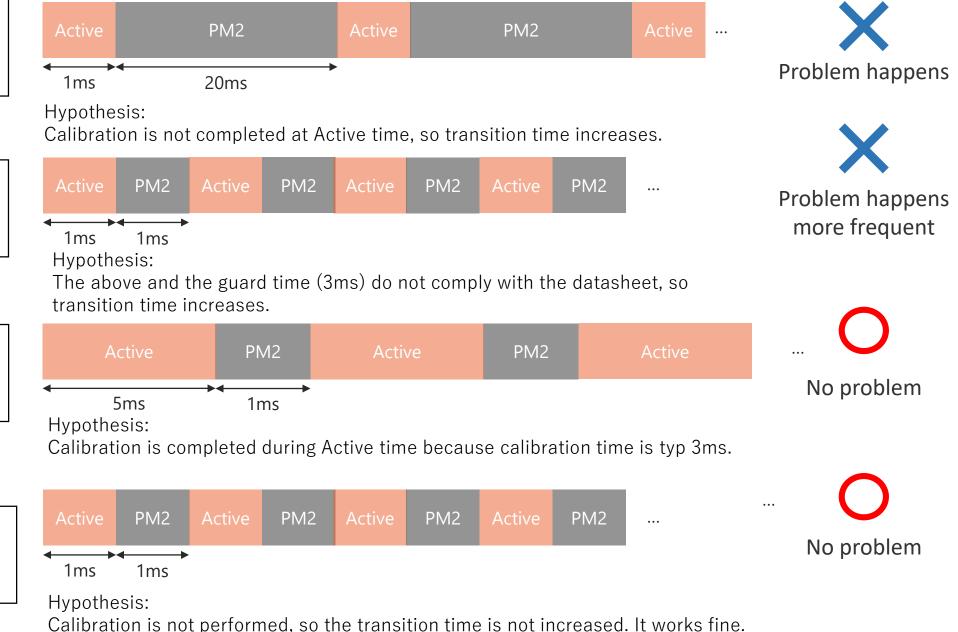
Internal 32kHz Enable 32kHz calibration Active 1ms / PM2 1ms

Experiment 3

Internal 32kHz Enable 32kHz calibration Active 5ms / PM2 1ms

Experiment 4

Internal 32kHz **Disable** 32kHz calibration Active 1ms / PM2 1ms

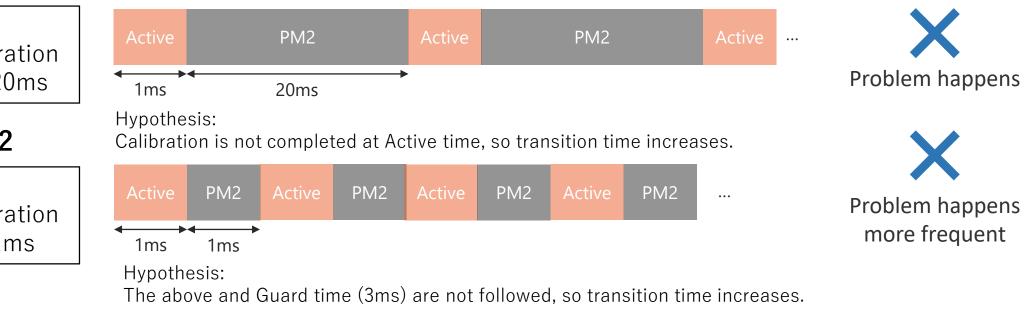


Experiment 1

Internal 32kHz Enable 32kHz calibration Active 1ms / PM2 20ms

Experiment 2

Internal 32kHz Enable 32kHz calibration Active 1ms / PM2 1ms



If the transition time is increased, interrupt may happen at the "Cannot be interrupted" timing in "Fixed time". If this happens, the device will miss the compare event and will not wake up from PM2.

Clock was carefully checked, but problems were not found.32MHz XOSC

If there are any other possible factors, please let me know.

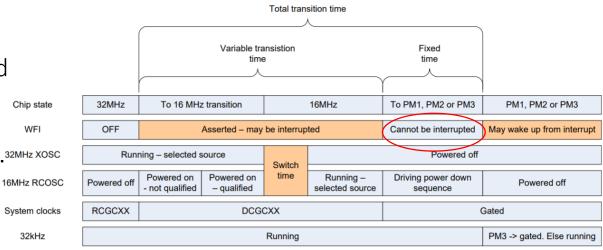


Figure 7-3. Timing Example for Transition from 32 MHz to PM's

5.10 32-kHz RC Oscillator

Measured on TI's CC2538 EM reference design with $T_A = 25^{\circ}C$ and $V_{DD} = 3 V$, unless otherwise noted.

PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
Calibrated frequency ⁽¹⁾			32.753		kHz
Frequency accuracy after calibration			±0.2%		
Temperature coefficient ⁽²⁾			0.4		%/ °C
Supply-voltage coefficient ⁽³⁾			3		%/V
Calibration time ⁽⁴⁾	(2		ms
					\sim

5.8 32-MHz Crystal Oscillator

Measured on TI's CC2538 EM reference design with $T_A = 25^{\circ}C$ and $V_{DD} = 3 V$, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Crystal frequency			32		MHz
	Crystal frequency accuracy requirement ⁽¹⁾		-40		40	ppm
ESR	Equivalent series resistance		6	16	60	Ω
C ₀	Crystal shunt capacitance		1	1.9	7	pF
CL	Crystal load capacitance		10	13	16	pF
	Start-up time			0.3		ms
	Power-down guard time	The crystal oscillator must be in power down for a guard time before using it again. This requirement is valid for all modes of operation. The need for power-down guard time can vary with crystal type and load.	3			ms